

GP 1725

PATENT
Docket No.: P2D7D1-US

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Michelle White

Michelle White

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

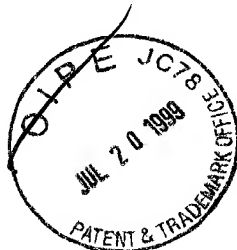
In the application of:

Igor Y. Khandros et al.

Application No.: 09/295,269

Filing Date: April 20, 1999

For: CONTACT STRUCTURE DEVICE FOR
INTERCONNECTIONS, INTERPOSER,
SEMICONDUCTOR ASSEMBLY AND
PACKAGE USING THE SAME AND
METHOD



Examiner: Not yet assigned

Group Art Unit: 1725

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PRELIMINARY AMENDMENT

AUG 09 1999

Assistant Commissioner for Patents
Washington, DC 20231

TECHNOLOGY CENTER 2800

Dear Sir:

Prior to examination of this application, Applicants respectfully request that the Examiner enter the following amendment.

IN THE TITLE

Please delete the current title "CONTACT STRUCTURE DEVICE FOR INTERCONNECTIONS, INTERPOSER, SEMICONDUCTOR ASSEMBLY AND PACKAGE USING THE SAME AND METHOD", and insert therefore --TIP STRUCTURES--.

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